



UNIVERSITY AT BUFFALO

State University of New York

SCHOOL OF ENGINEERING

AND APPLIED SCIENCES



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TELEPARTICIPATION IN NEES COLLABORATORY

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Structural Engineering and Earthquake Simulation Laboratory



Concept of Tele-Participation

■ Experimentation

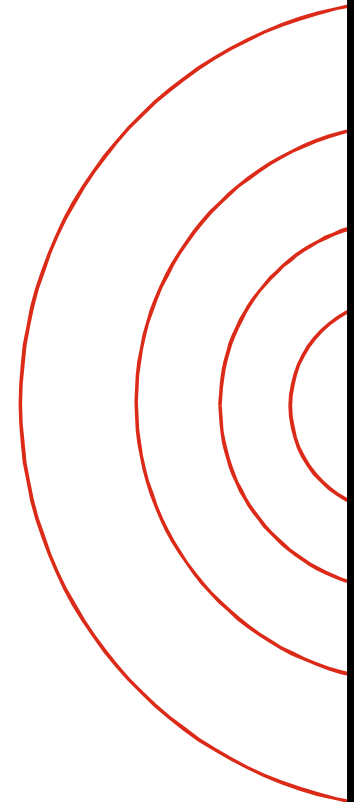
- Preparation of Experiments
- Calibration of instruments and experiments
- Activation and control of experiments

■ Observation

- Selection and manipulation of data
- Manipulation of instruments and sensors
- Processing of instruments data

■ Simulation and feedback

- Development of pre-testing model
- Manipulation of models during testing
- Identification of model parameters and simulations





Outline

- NEES / Node operations
- Teleparticipation concept
- Examples of low level teleparticipation
- Examples of high level teleparticipation (live)
- Equipment chart





Experimental Research

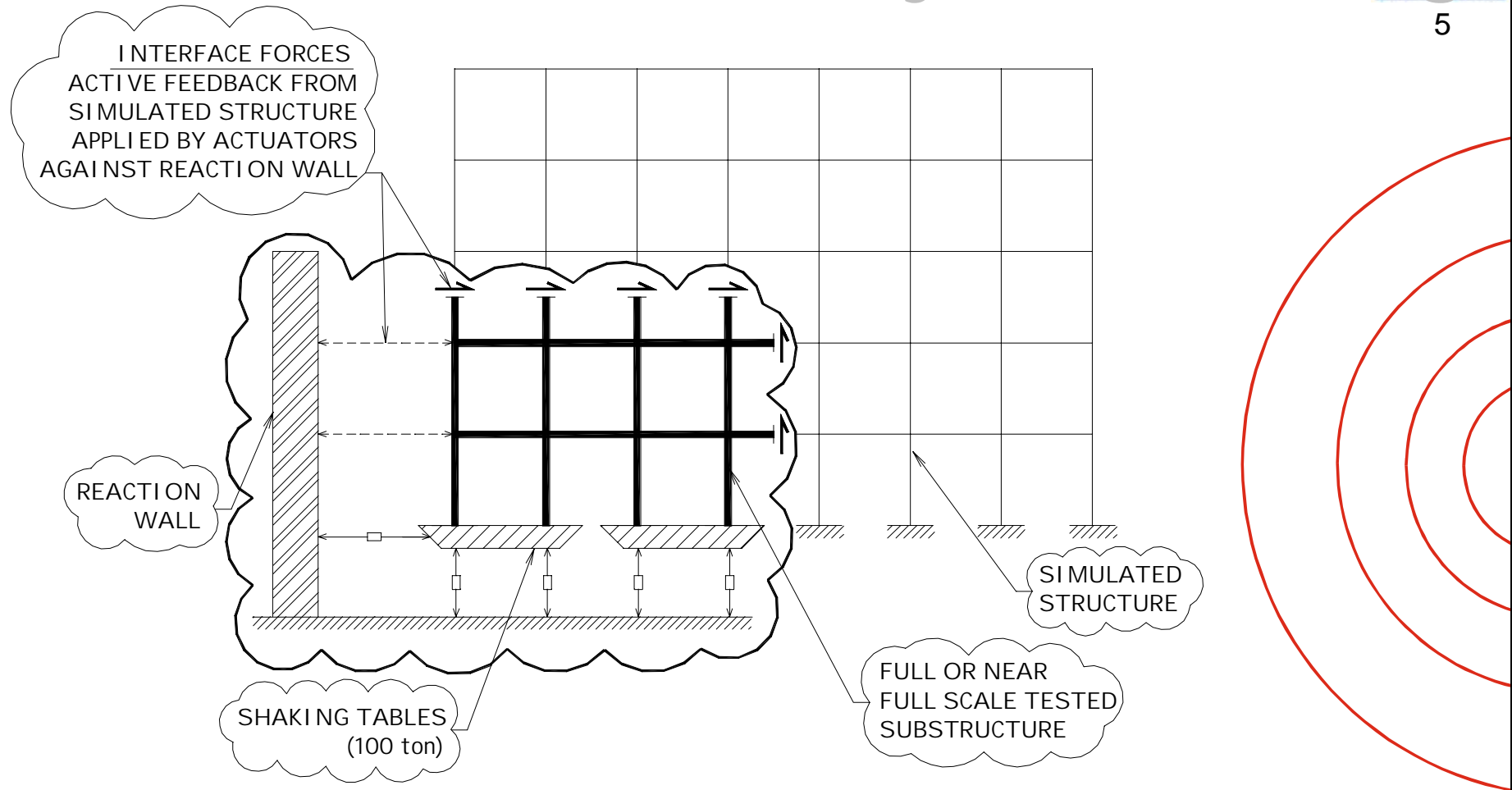
- “Analysis → Testing → Analysis → Testing → Analysis → ... an endless cycle”

V.V.Bertero

- Final product is a **computational model** for engineering decisions



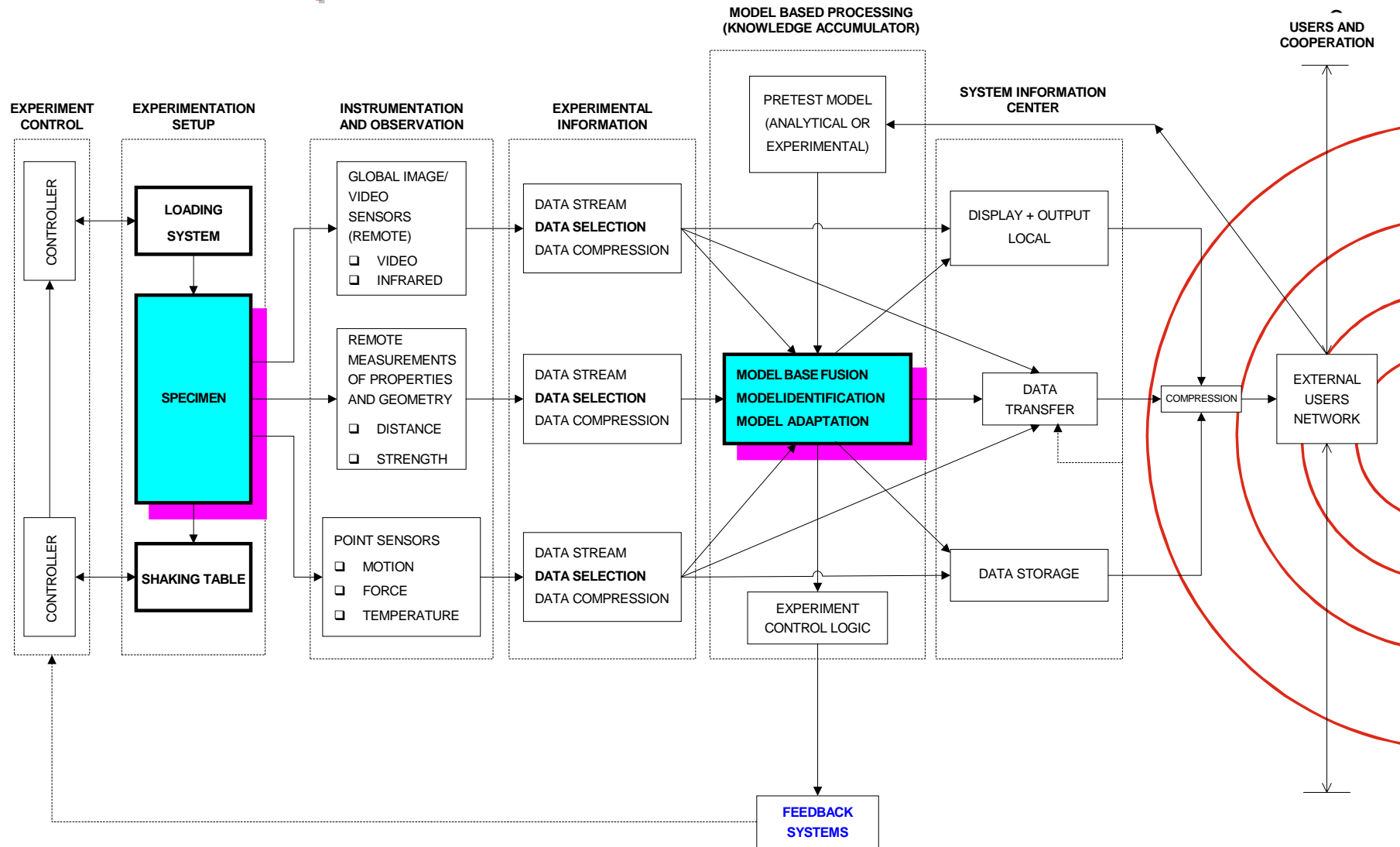
Real-Time Seismic Hybrid Testing



**Fig.1. Real-Time Hybrid Seismic Testing System
(Substructure Dynamic Testing)**

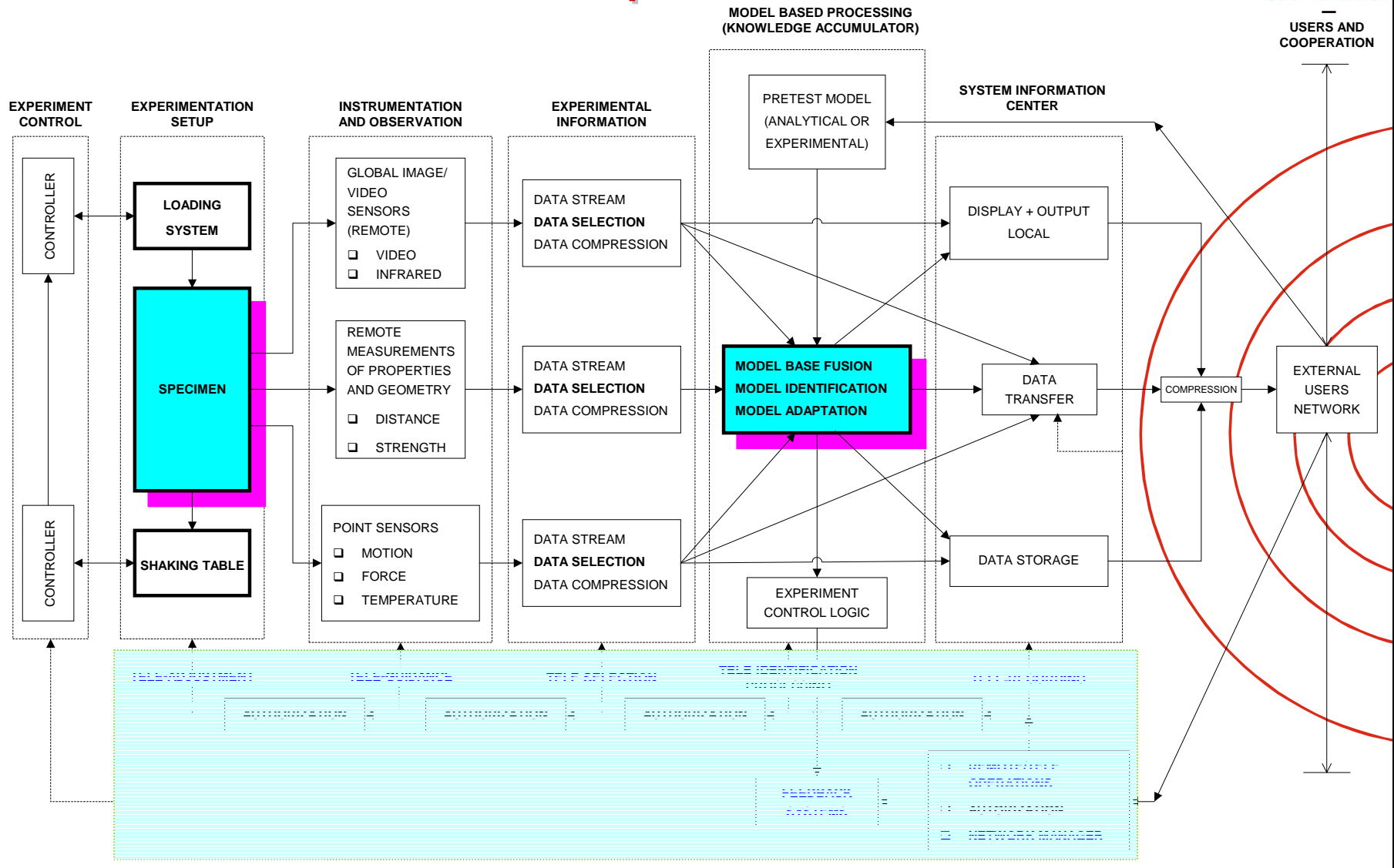


Node Operations





Node with Teleparticipation





Tele-participation

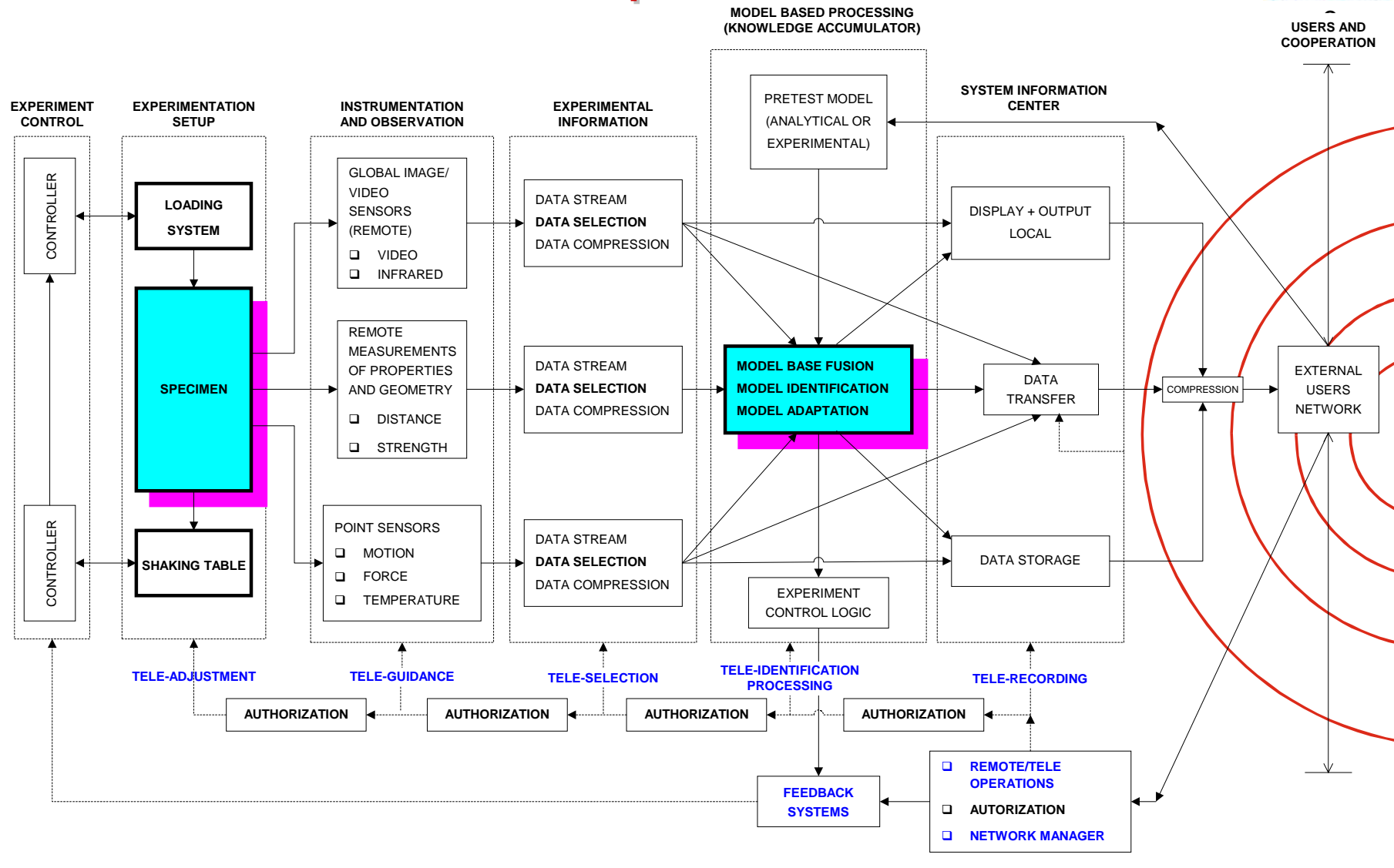
Teleparticipation components

- Experiment **tele-control**
- Experiment **tele-adjustment** (input, etc)
- **Tele-guidance** of instruments and equipment
- **Tele-selection** of data channels and information
- **Tele-processing** of data and knowledge accumulation
- **Tele-recording** and transfer of data and models
- **Tele-planning** of experiments

The above are hierarchical activities depending of node scope and operations



Node with Teleparticipation



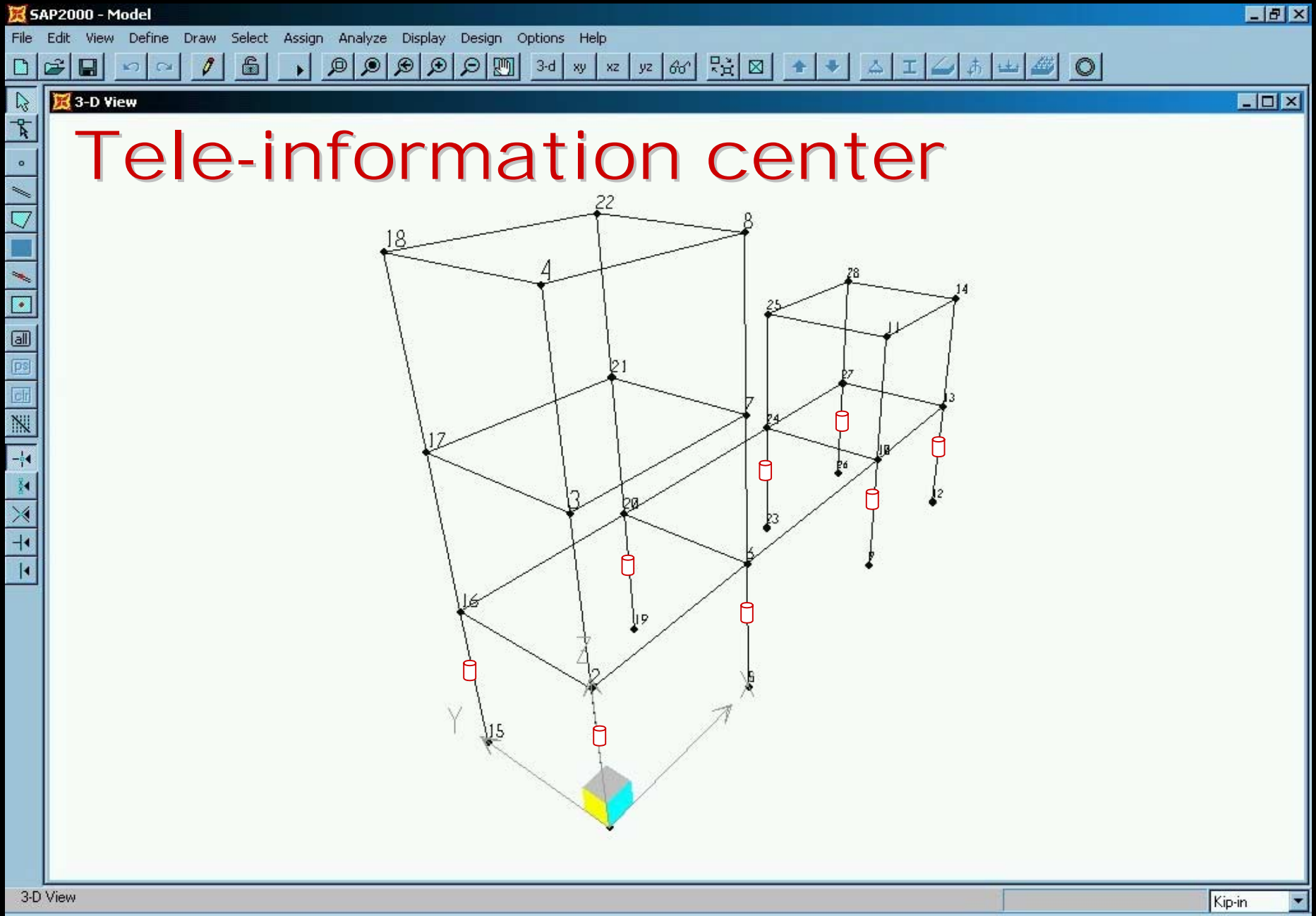


Examples of low level tele-participation

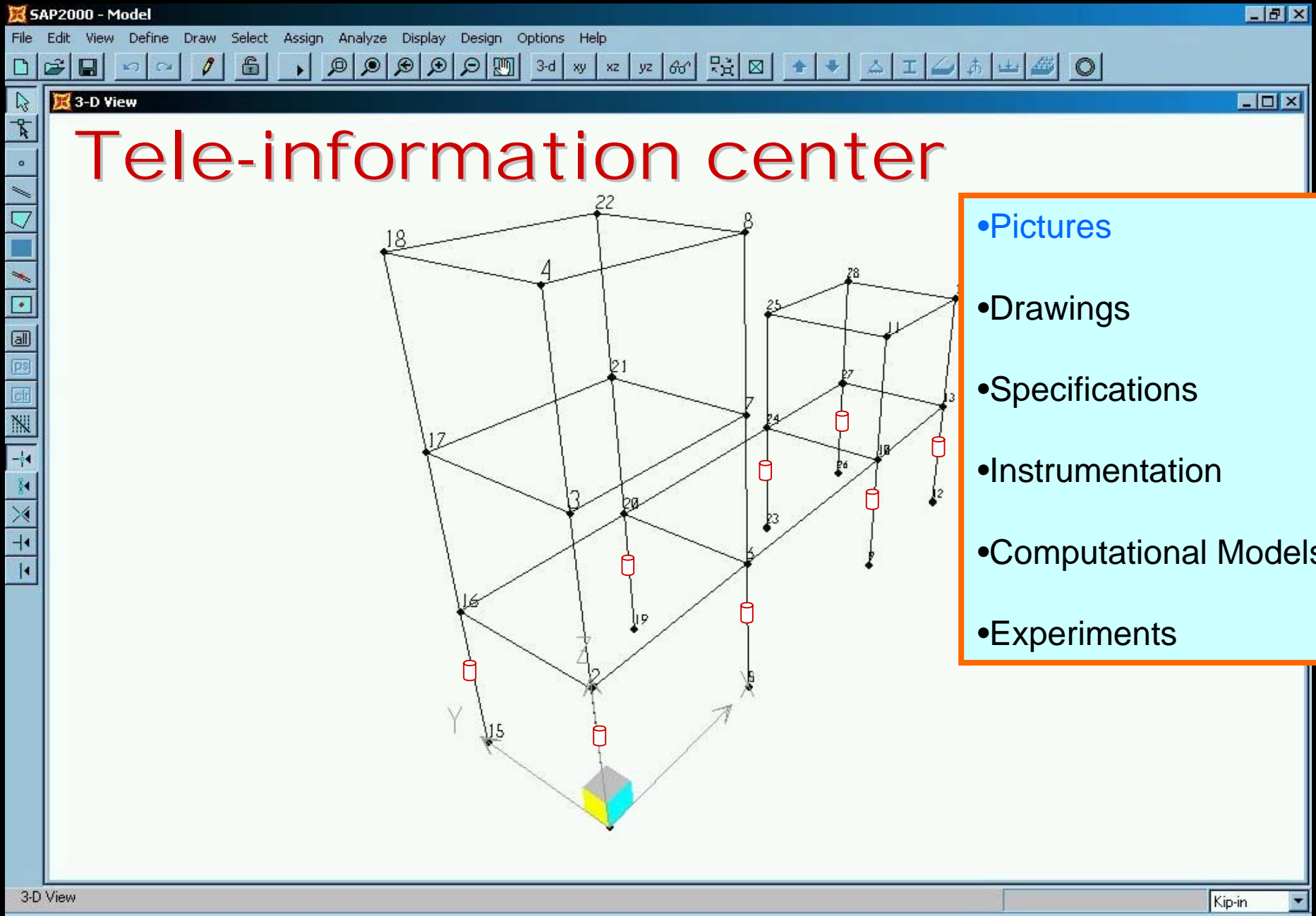
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The above are hierarchical activities depending of node scope and operations



Tele-information center



Tele-information center

- Pictures
- Drawings
- Specifications
- Instrumentation
- Computational Models
- Experiments

Benchmark Model - Task 4.1-4.2 Users networks - Year 4 of MCEER



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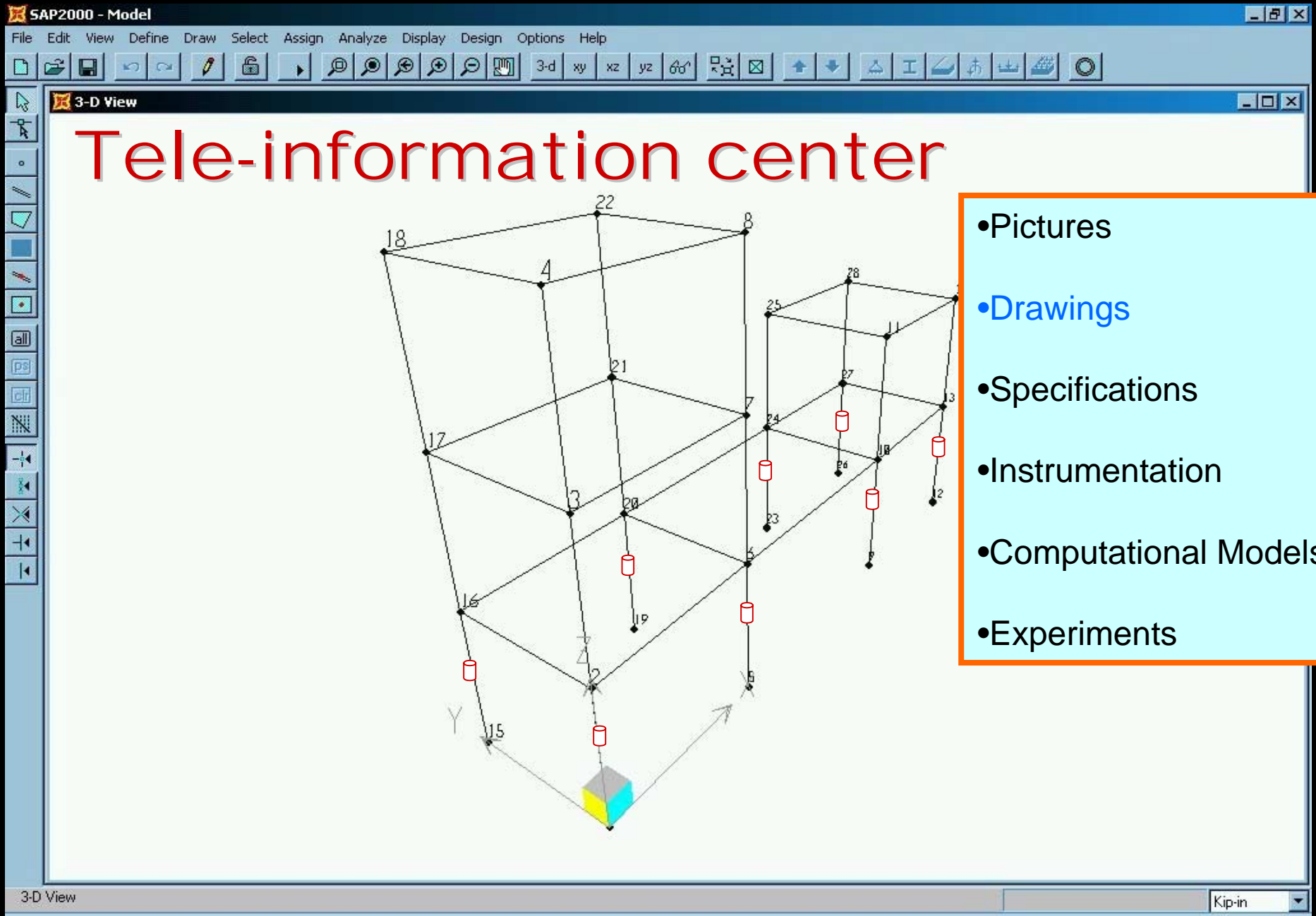


Benchmark Model - Task 4.1-4.2 Users networks - Year 4 of MCEER



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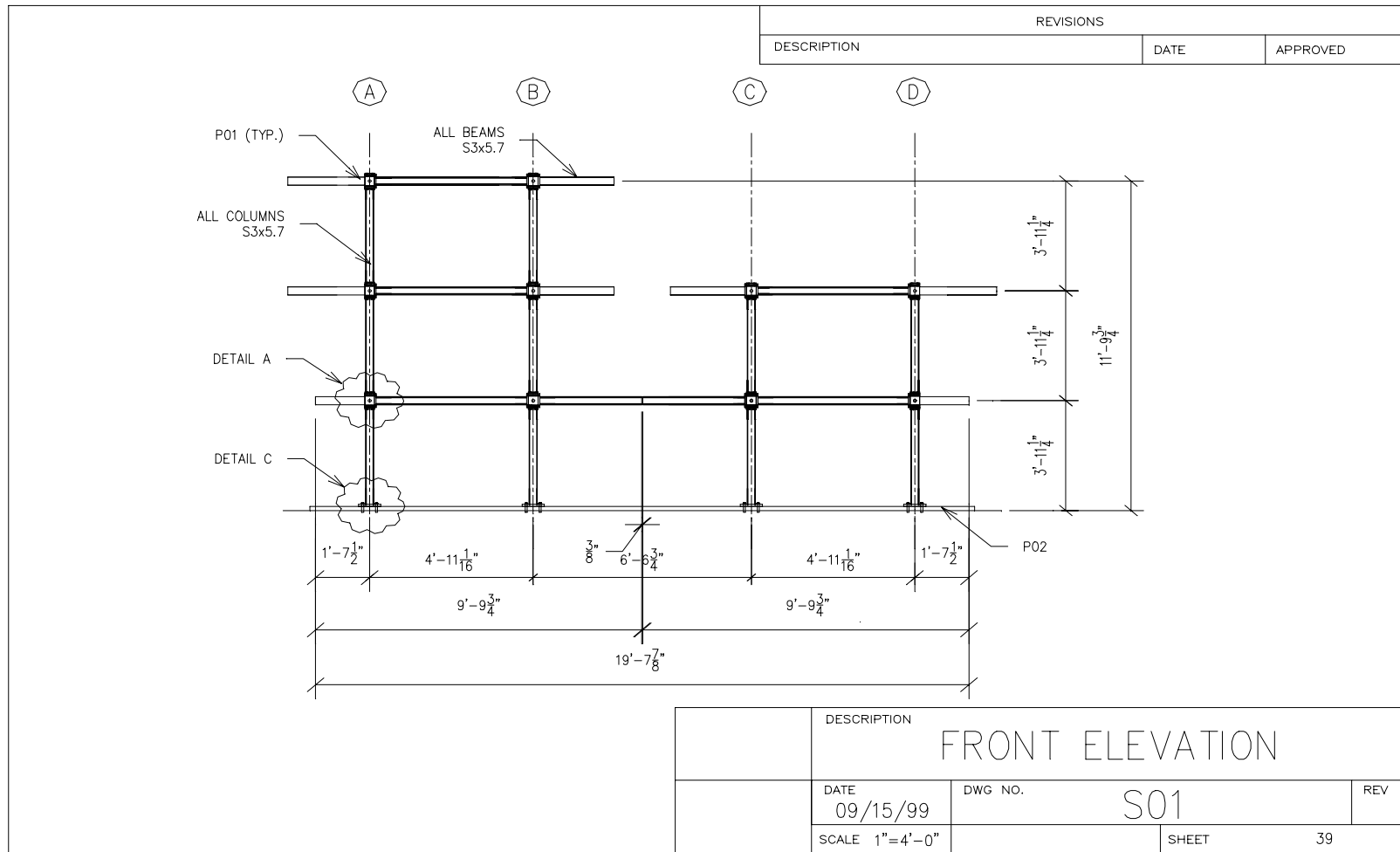


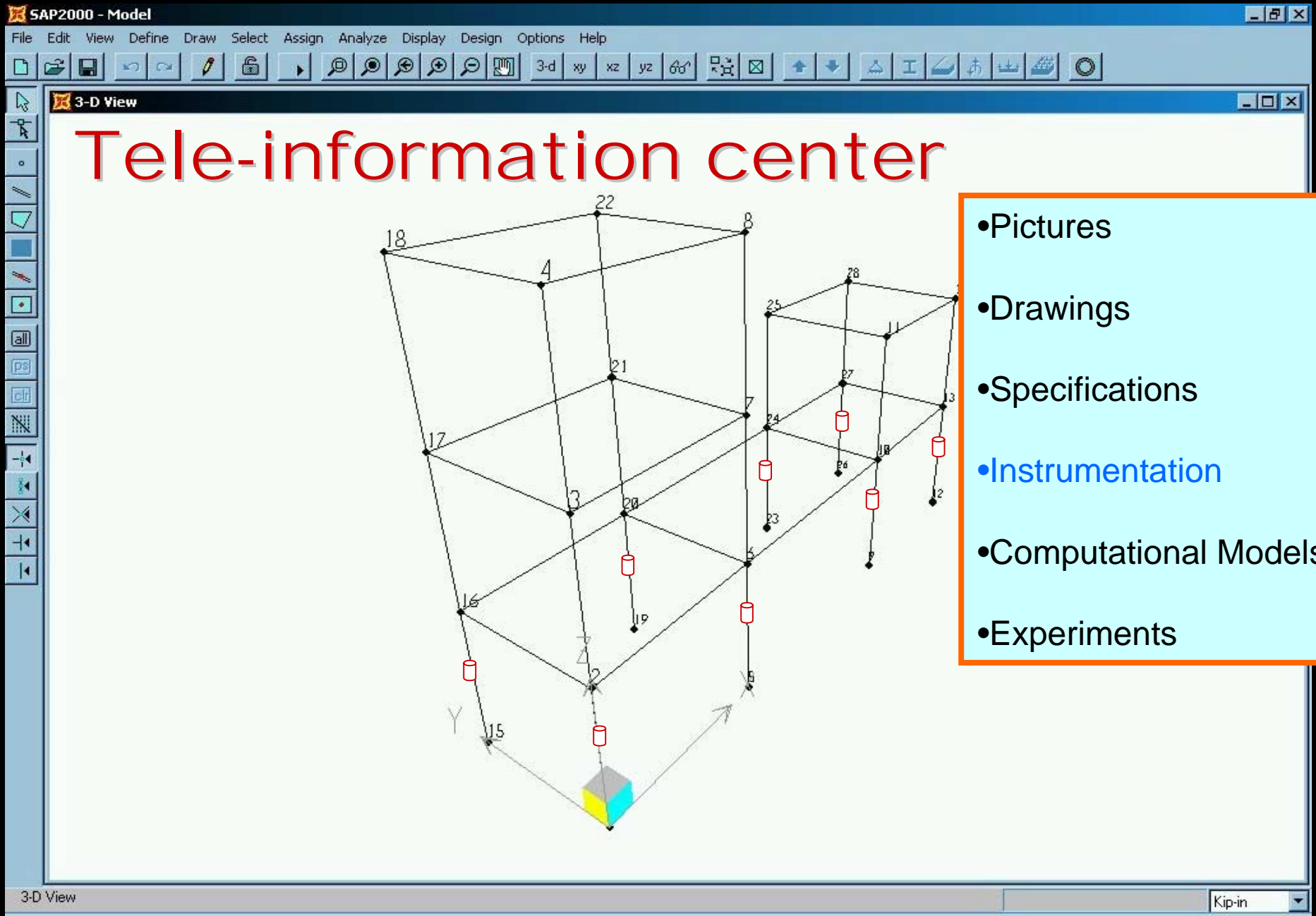


- Pictures
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- Specifications
- Instrumentation
- Computational Models
- Experiments



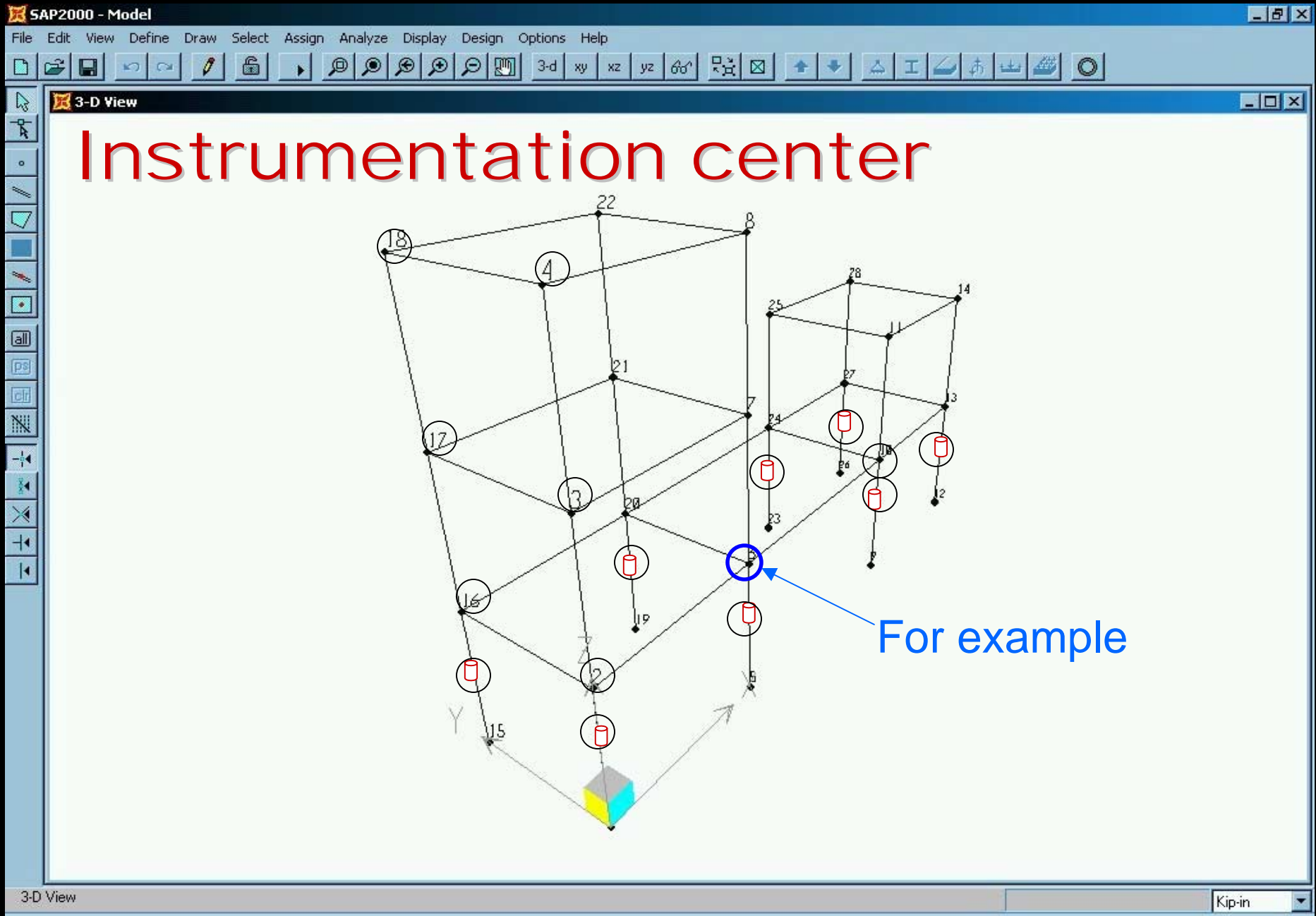
Model Structure





Tele-information center

- Pictures
- Drawings
- Specifications
- Instrumentation
- Computational Models
- Experiments



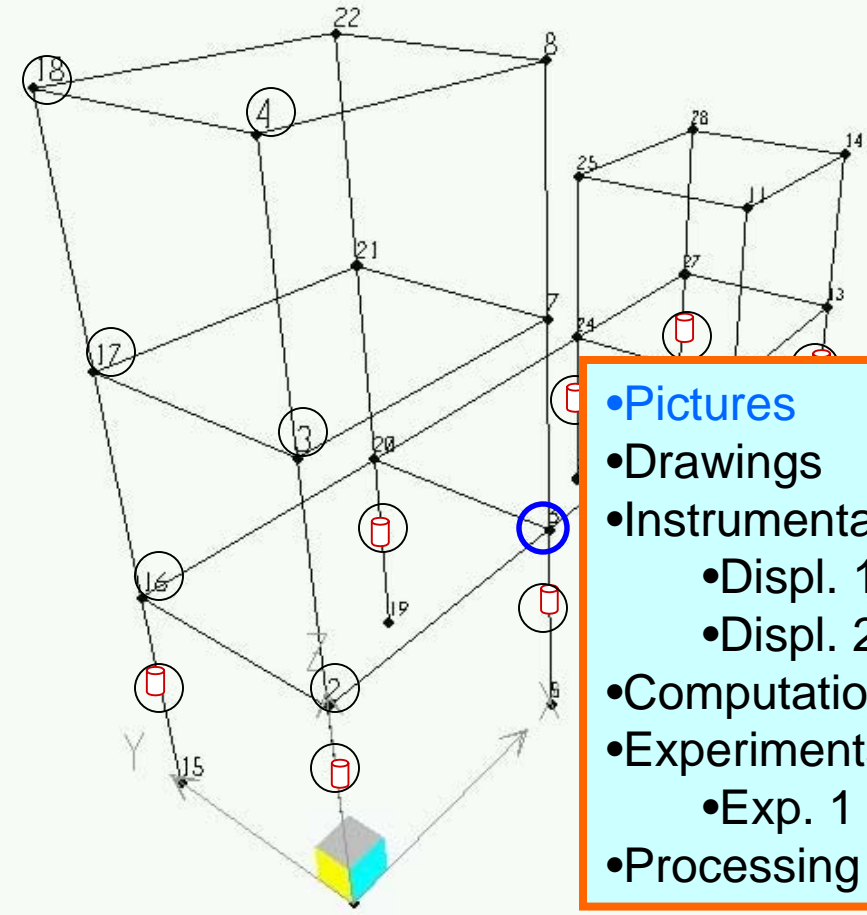
For example

SAP2000 - Model

File Edit View Define Draw Select Assign Analyze Display Design Options Help

3-D View

Instrumentation center



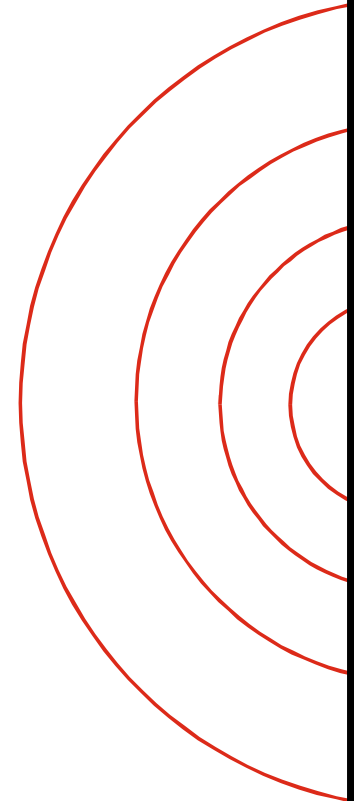
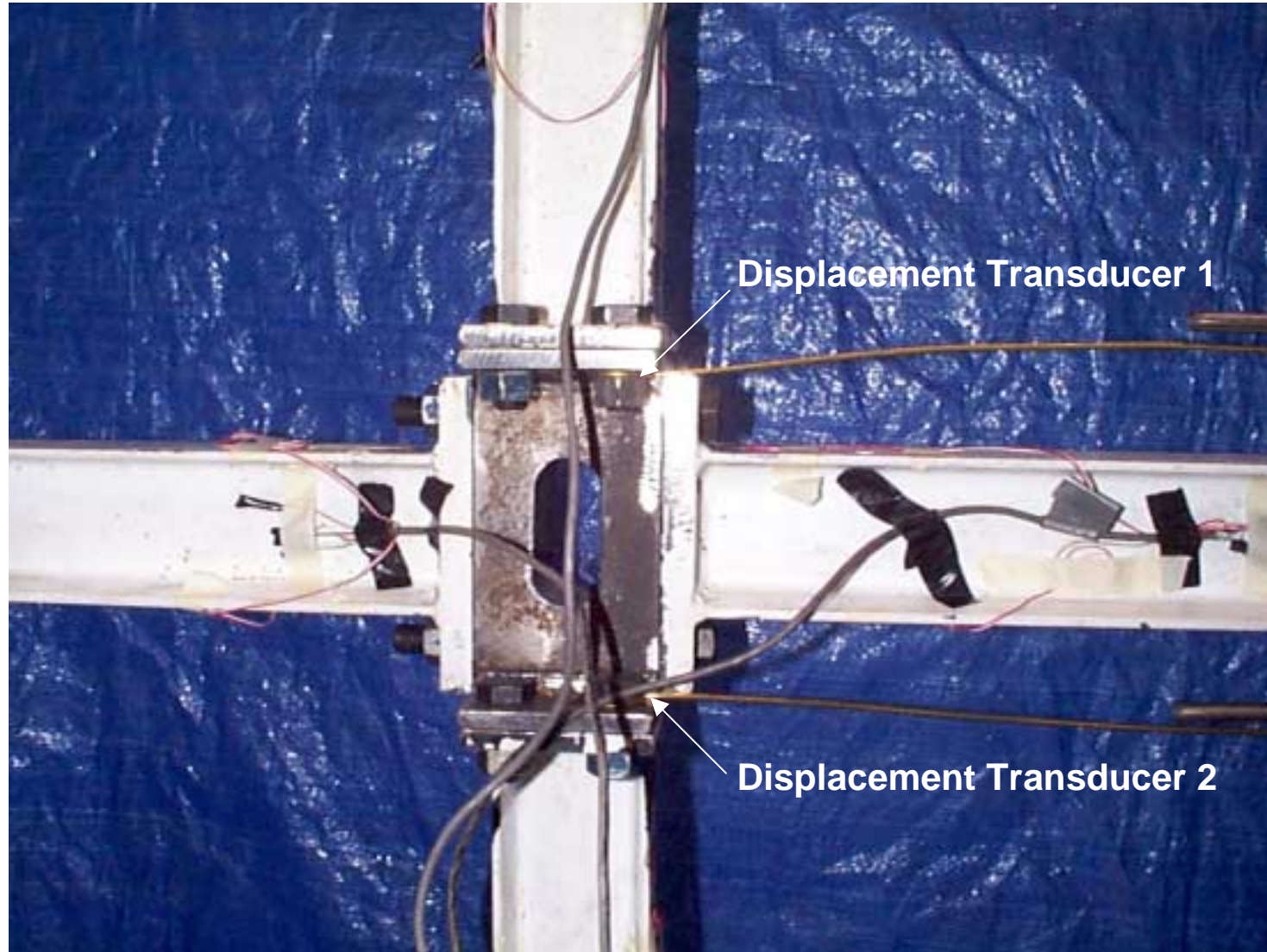
- Pictures
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- Instrumentation
 - Displ. 1
 - Displ. 2
- Computational Data
- Experiments Data
 - Exp. 1
- Processing Tools

3-D View Kip-in

Location of Sensor



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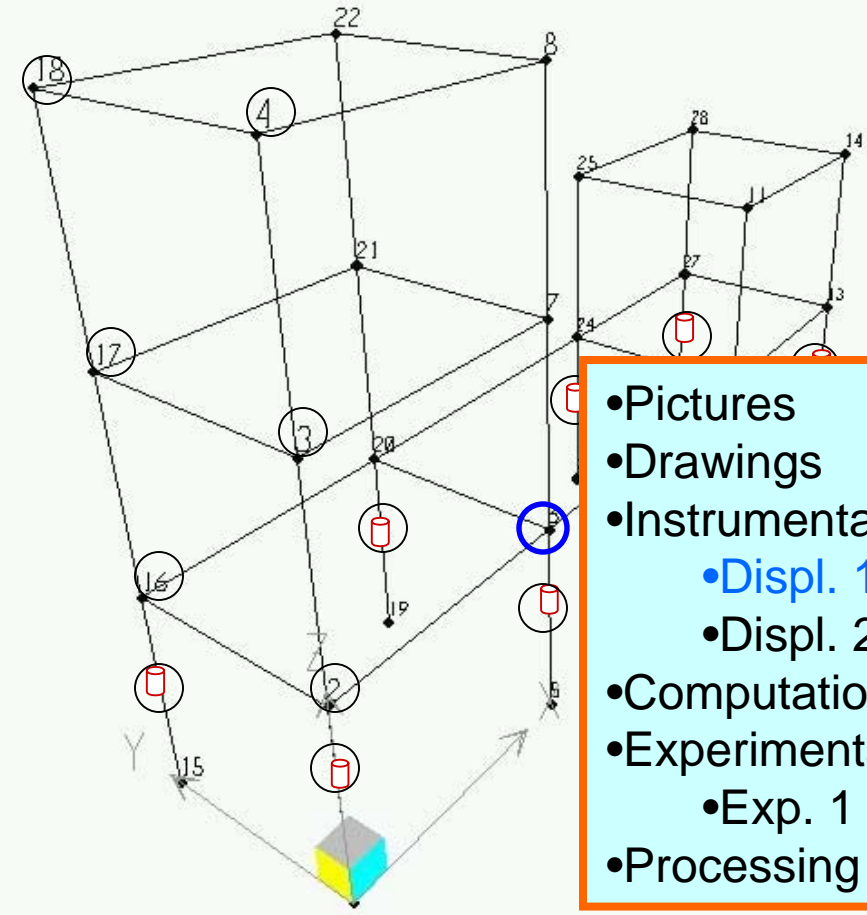


SAP2000 - Model

File Edit View Define Draw Select Assign Analyze Display Design Options Help

3-D View

Instrumentation center



The image shows a 3D wireframe model of a building structure. The main structure is a multi-story frame with nodes labeled 1 through 22. A smaller structure is visible to the right with nodes 1 through 28. Several red rectangular icons representing instrumentation points are placed at various nodes, including nodes 1, 2, 3, 4, 12, 13, 14, 15, 16, 17, 18, 19, 20, 21, 22, 23, 24, 25, 26, 27, and 28. A blue circle highlights node 19. A 3D coordinate system with X, Y, and Z axes is shown at the bottom left. A status bar at the bottom left reads '3-D View' and the bottom right shows 'Kip-in'.

- Pictures
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Instrument Information

Temposonics

Type: Temposonics™II Linear Displacement Transducer

Description: Measure displacement with a high degree of resolution by precisely sensing the position of an external magnet.

Features:

- Stroke lengths of ± 6 inches.
- Multiple position sensing capabilities
- Variety of output formats (digital and analog)
- Sensitivity of 0.6 in./volt



Calibration:

Reference Instrument:

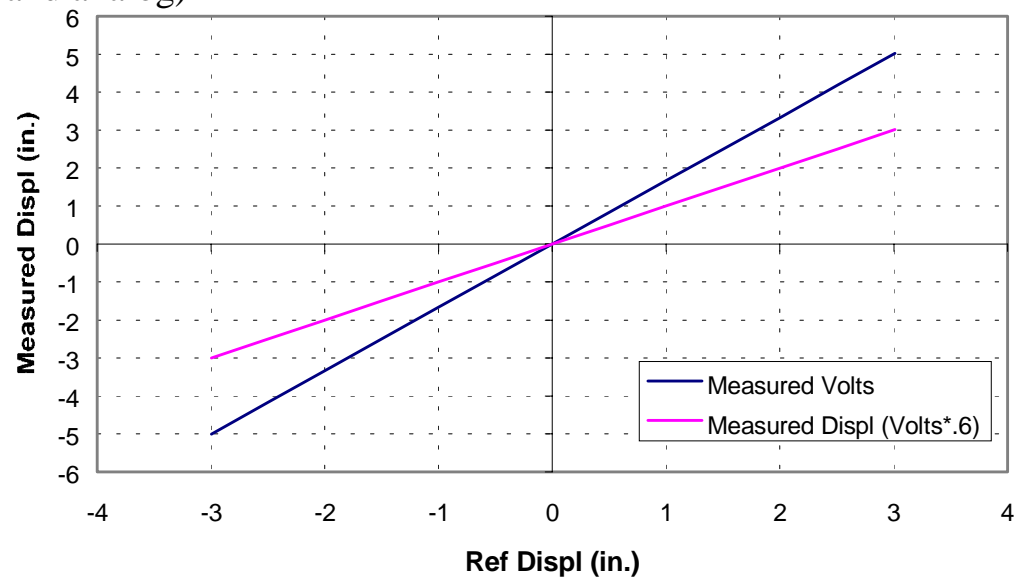
Digital meter Model x No 2432

Last Calibration:

Jan. 30, 2000 (ref.)

Jan. 30, 2001 (this)

Calibration of Reference Temposonic

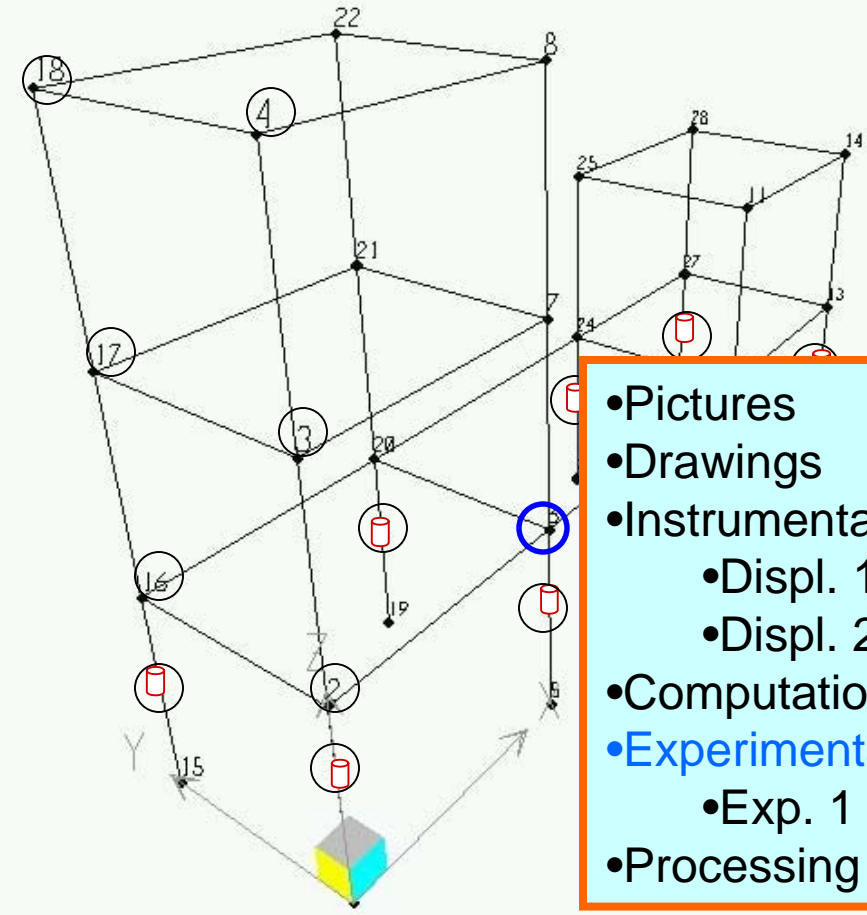


SAP2000 - Model

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3-D View

Instrumentation center



The image shows a 3D wireframe model of a building structure. The main structure is a multi-story frame with nodes labeled 1 through 22. A smaller structure is visible to the right with nodes 1 through 28. Several nodes are marked with red circles containing a white square, representing instrumentation points. A blue circle highlights node 19. A 3D coordinate system (X, Y, Z) is shown at the bottom left, with a yellow and blue cube at the origin.

- Pictures
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3-D View Kip-in

